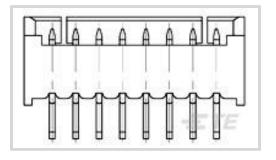
1734598-9 - ACTIVE

TE Internal #: 1734598-9 PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 1.25 mm [. 049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 1.25 mm Headers



Connector System: Wire-to-Board

Number of Positions: **9**

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in]

PCB Mount Orientation: Vertical

All AMP HPI 1.25 mm Headers (100)

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	9
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	100 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
PCB Contact Termination Area Plating Material Thickness	3.08 μm[120 μin]
Contact Layout	Inline

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PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Jsage Conditions	
Connector Height Connector Width	4.7 mm[.105 m] 3.2 mm[.126 in]
Connector Height	13 mm[.511 in] 4.7 mm[.185 in]
	12 mm[511 m]
Dimensions	
Centerline (Pitch)	1.25 mm[.049 in]
Housing Material	PA 9T GF
lousing Features	
PCB Mount Retention	Without
PCB Mount Alignment	Without
Mating Alignment	With
Mating Retention Connector Mounting Type	Board Mount
Mating Alignment Type	Without
	Polarization
/lechanical Attachment	
Termination Method to Printed Circuit Board	Through Hole - Solder
Termination Post & Tail Length	1.7 mm[.067 in]
Rectangular Termination Post & Tail Width	.35 mm[.014 in]
Rectangular Termination Post & Tail Thickness	.3 mm[.012 in]
ermination Features	
Contact Current Rating (Max)	.8 A
Contact Type	Pin
Contact Mating Area Plating Material	Tin
PCB Contact Termination Area Plating Material Contact Base Material	Tin Phosphor Bronze
Contact Underplating Material	Nickel
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material Finish	Matte
Mating Tab Thickness	.3 mm[.012 in]

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09/19/2023 03:09PM | Page 2

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	47
Packaging Type	Box, Tube
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant Compliant
EU ELV Directive 2000/53/EC	Compliant
EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016	Compliant No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUL 2021 (219)

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural





Customers Also Bought







Documents

Product Drawings 1.25 WTB HDR DIP, 9 POS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1734598-9_R.2d_dxf.zip

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



English

Customer View Model ENG_CVM_CVM_1734598-9_R.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1734598-9_R.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages HPI Connectors QRG

English

Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance

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Product Compliance

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